

Important notice

Dear Customer,

On 7 February 2017 the former NXP Standard Product business became a new company with the tradename **Nexperia**. Nexperia is an industry leading supplier of Discrete, Logic and PowerMOS semiconductors with its focus on the automotive, industrial, computing, consumer and wearable application markets

In data sheets and application notes which still contain NXP or Philips Semiconductors references, use the references to Nexperia, as shown below.

Instead of <http://www.nxp.com>, <http://www.philips.com/> or <http://www.semiconductors.philips.com/>, use <http://www.nexperia.com>

Instead of sales.addresses@www.nxp.com or sales.addresses@www.semiconductors.philips.com, use salesaddresses@nexperia.com (email)

Replace the copyright notice at the bottom of each page or elsewhere in the document, depending on the version, as shown below:

- © NXP N.V. (year). All rights reserved or © Koninklijke Philips Electronics N.V. (year). All rights reserved

Should be replaced with:

- © **Nexperia B.V. (year). All rights reserved.**

If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via salesaddresses@nexperia.com). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

DATA SHEET

74ABT241

Octal buffer/line driver (3-State)

Product specification
Supersedes data of 1996 Sep 25
IC23 Data Handbook

1998 Jan 16

Octal buffer/line driver (3-State)

74ABT241

FEATURES

- Octal bus interface
- 3-State buffers
- Power-up 3-State
- Output capability: +64mA/−32mA
- Latch-up protection exceeds 500mA per Jedec Std 17
- ESD protection exceeds 2000 V per MIL STD 883 Method 3015 and 200 V per Machine Model
- Inputs are disabled during 3-State mode

DESCRIPTION

The 74ABT241 high-performance BiCMOS device combines low static and dynamic power dissipation with high speed and high output drive.

The 74ABT241 device is an octal buffer that is ideal for driving bus lines. The device features two Output Enables ($1\overline{OE}$, $2OE$), each controlling four of the 3-State outputs.

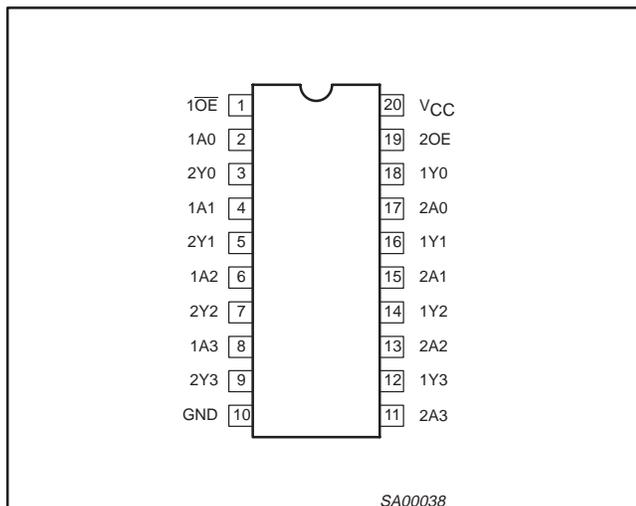
QUICK REFERENCE DATA

| SYMBOL | PARAMETER | CONDITIONS $T_{amb} = 25^{\circ}\text{C}; \text{GND} = 0\text{V}$ | TYPICAL | UNIT |
|------------------------|-------------------------------|--|------------|---------------|
| t_{PLH} t_{PHL} | Propagation delay An to Yn | $C_L = 50\text{pF}; V_{CC} = 5\text{V}$ | 2.6 2.7 | ns |
| C_{IN} | Input capacitance | $V_I = 0\text{V}$ or V_{CC} | 3 | pF |
| C_{OUT} | Output capacitance | Outputs disabled; $V_O = 0\text{V}$ or V_{CC} | 7 | pF |
| I_{CCZ} | Total supply current | Outputs disabled; $V_{CC} = 5.5\text{V}$ | 50 | μA |

ORDERING INFORMATION

| PACKAGES | TEMPERATURE RANGE | OUTSIDE NORTH AMERICA | NORTH AMERICA | DWG NUMBER |
|-----------------------------|-------------------|-----------------------|---------------|------------|
| 20-Pin Plastic DIP | −40°C to +85°C | 74ABT241 N | 74ABT241 N | SOT146-1 |
| 20-Pin plastic SO | −40°C to +85°C | 74ABT241 D | 74ABT241 D | SOT163-1 |
| 20-Pin Plastic SSOP Type II | −40°C to +85°C | 74ABT241 DB | 74ABT241 DB | SOT339-1 |
| 20-Pin Plastic TSSOP Type I | −40°C to +85°C | 74ABT241 PW | 74ABT241PW DH | SOT360-1 |

PIN CONFIGURATION



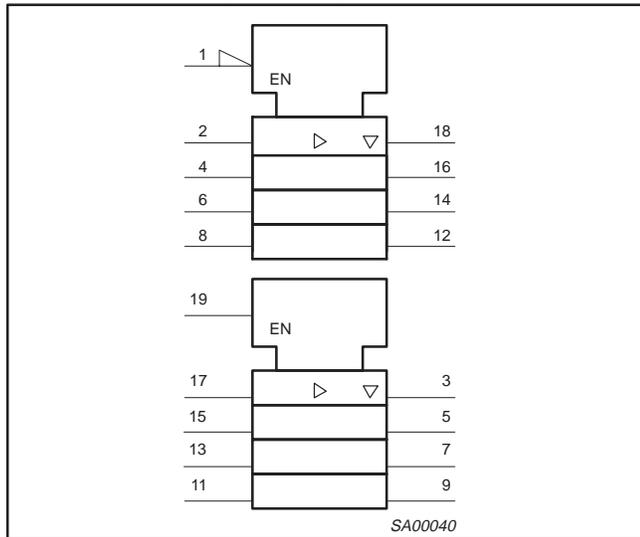
PIN DESCRIPTION

| PIN NUMBER | SYMBOL | NAME AND FUNCTION |
|----------------|------------------------|-------------------------|
| 2, 4, 6, 8 | 1A0 – 1A3 | Data inputs |
| 17, 15, 13, 11 | 2A0 – 2A3 | Data inputs |
| 18, 16, 14, 12 | 1Y0 – 1Y3 | Data outputs |
| 3, 5, 7, 9 | 2Y0 – 2Y3 | Data outputs |
| 1, 19 | $1\overline{OE}$, 2OE | Output enables |
| 10 | GND | Ground (0V) |
| 20 | V_{CC} | Positive supply voltage |

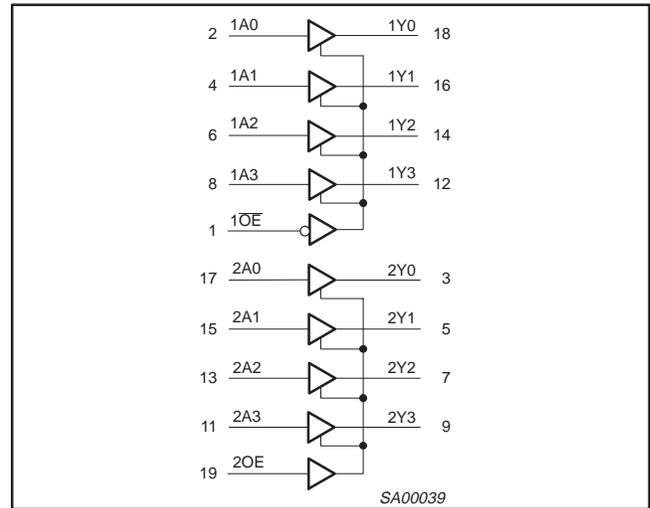
Octal buffer/line driver (3-State)

74ABT241

LOGIC SYMBOL (IEEE/IEC)



LOGIC SYMBOL



FUNCTION TABLE

| INPUTS | | | | OUTPUTS | |
|--------|-----|-----|-----|---------|-----|
| 1OE | 1An | 2OE | 2An | 1Yn | 2Yn |
| L | L | H | L | L | L |
| L | H | H | H | H | H |
| H | X | L | X | Z | Z |

H = High voltage level
 L = Low voltage level
 X = Don't care
 Z = High impedance "off" state

ABSOLUTE MAXIMUM RATINGS^{1, 2}

| SYMBOL | PARAMETER | CONDITIONS | RATING | UNIT |
|------------------|--------------------------------|-----------------------------|--------------|------|
| V _{CC} | DC supply voltage | | -0.5 to +7.0 | V |
| I _{IK} | DC input diode current | V _I < 0 | -18 | mA |
| V _I | DC input voltage ³ | | -1.2 to +7.0 | V |
| I _{OK} | DC output diode current | V _O < 0 | -50 | mA |
| V _{OUT} | DC output voltage ³ | output in Off or High state | -0.5 to +5.5 | V |
| I _{OUT} | DC output current | output in Low state | 128 | mA |
| T _{stg} | Storage temperature range | | -65 to 150 | °C |

NOTES:

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
- The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

Octal buffer/line driver (3-State)

74ABT241

RECOMMENDED OPERATING CONDITIONS

| SYMBOL | PARAMETER | LIMITS | | UNIT |
|---------------------|--------------------------------------|--------|----------|------|
| | | Min | Max | |
| V_{CC} | DC supply voltage | 4.5 | 5.5 | V |
| V_I | Input voltage | 0 | V_{CC} | V |
| V_{IH} | High-level input voltage | 2.0 | | V |
| V_{IL} | Low-level Input voltage | | 0.8 | V |
| I_{OH} | High-level output current | | -32 | mA |
| I_{OL} | Low-level output current | | 64 | mA |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | 0 | 5 | ns/V |
| T_{amb} | Operating free-air temperature range | -40 | +85 | °C |

DC ELECTRICAL CHARACTERISTICS

| SYMBOL | PARAMETER | TEST CONDITIONS | LIMITS | | | | | UNIT |
|-----------------|--|---|-------------------------------|------------|-----------|---|-----------|---------------|
| | | | $T_{amb} = +25^\circ\text{C}$ | | | $T_{amb} = -40^\circ\text{C}$ to $+85^\circ\text{C}$ | | |
| | | | Min | Typ | Max | Min | Max | |
| V_{IK} | Input clamp voltage | $V_{CC} = 4.5\text{V}; I_{IK} = -18\text{mA}$ | | -0.9 | -1.2 | | -1.2 | V |
| V_{OH} | High-level output voltage | $V_{CC} = 4.5\text{V}; I_{OH} = -3\text{mA}; V_I = V_{IL}$ or V_{IH} | 2.5 | 2.9 | | 2.5 | | V |
| | | $V_{CC} = 5.0\text{V}; I_{OH} = -3\text{mA}; V_I = V_{IL}$ or V_{IH} | 3.0 | 3.4 | | 3.0 | | V |
| | | $V_{CC} = 4.5\text{V}; I_{OH} = -32\text{mA}; V_I = V_{IL}$ or V_{IH} | 2.0 | 2.4 | | 2.0 | | V |
| V_{OL} | Low-level output voltage | $V_{CC} = 4.5\text{V}; I_{OL} = 64\text{mA}; V_I = V_{IL}$ or V_{IH} | | 0.42 | 0.55 | | 0.55 | V |
| I_I | Input leakage current | $V_{CC} = 5.5\text{V}; V_I = \text{GND}$ or 5.5V | | ± 0.01 | ± 1.0 | | ± 1.0 | μA |
| I_{OFF} | Power-off leakage current | $V_{CC} = 0.0\text{V}; V_I$ or $V_O \leq 4.5\text{V}$ | | ± 5.0 | ± 100 | | ± 100 | μA |
| I_{PU}/I_{PD} | Power-up/down 3-State output current ³ | $V_{CC} = 2.0\text{V}; V_O = 0.5\text{V}; V_I = \text{GND}$ or V_{CC} ; $V_{OE} = V_{CC}$; $V_{OE} = \text{GND}$ | | ± 5.0 | ± 50 | | ± 50 | μA |
| I_{OZH} | 3-State output High current | $V_{CC} = 5.5\text{V}; V_O = 2.7\text{V}; V_I = V_{IL}$ or V_{IH} | | 5.0 | 50 | | 50 | μA |
| I_{OZL} | 3-State output Low current | $V_{CC} = 5.5\text{V}; V_O = 0.5\text{V}; V_I = V_{IL}$ or V_{IH} | | -5.0 | -50 | | -50 | μA |
| I_{CEX} | Output High leakage current | $V_{CC} = 5.5\text{V}; V_O = 5.5\text{V}; V_I = \text{GND}$ or V_{CC} | | 5.0 | 50 | | 50 | μA |
| I_O | Output current ¹ | $V_{CC} = 5.5\text{V}; V_O = 2.5\text{V}$ | -50 | -100 | -180 | -50 | -180 | mA |
| I_{CCH} | Quiescent supply current | $V_{CC} = 5.5\text{V}$; Outputs High, $V_I = \text{GND}$ or V_{CC} | | 50 | 250 | | 250 | μA |
| I_{CCL} | | $V_{CC} = 5.5\text{V}$; Outputs Low, $V_I = \text{GND}$ or V_{CC} | | 24 | 30 | | 30 | mA |
| I_{CCZ} | | $V_{CC} = 5.5\text{V}$; Outputs 3-State; $V_I = \text{GND}$ or V_{CC} | | 50 | 250 | | 250 | μA |
| ΔI_{CC} | Additional supply current per input pin ² | Outputs enabled, one input at 3.4V, other inputs at V_{CC} or GND; $V_{CC} = 5.5\text{V}$ | | 0.5 | 1.5 | | 1.5 | mA |
| | | Outputs 3-State, one data input at 3.4V, other inputs at V_{CC} or GND; $V_{CC} = 5.5\text{V}$ | | 50 | 250 | | 250 | μA |
| | | Outputs 3-State, one enable input at 3.4V, other inputs at V_{CC} or GND; $V_{CC} = 5.5\text{V}$ | | 0.5 | 1.5 | | 1.5 | mA |

NOTES:

- Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
- This is the increase in supply current for each input at 3.4V.
- This parameter is valid for any V_{CC} between 0V and 2.1V with a transition time of up to 10msec. For $V_{CC} = 2.1\text{V}$ to $V_{CC} = 5\text{V} \pm 10\%$, a transition time of up to 100 μsec is permitted.

Octal buffer/line driver (3-State)

74ABT241

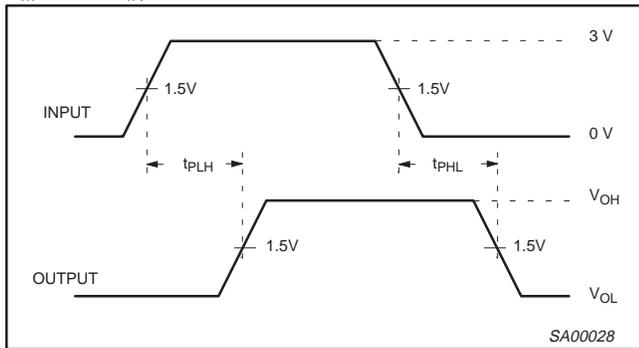
AC CHARACTERISTICS

GND = 0V; $t_R = t_F = 2.5\text{ns}$; $C_L = 50\text{pF}$, $R_L = 500\Omega$

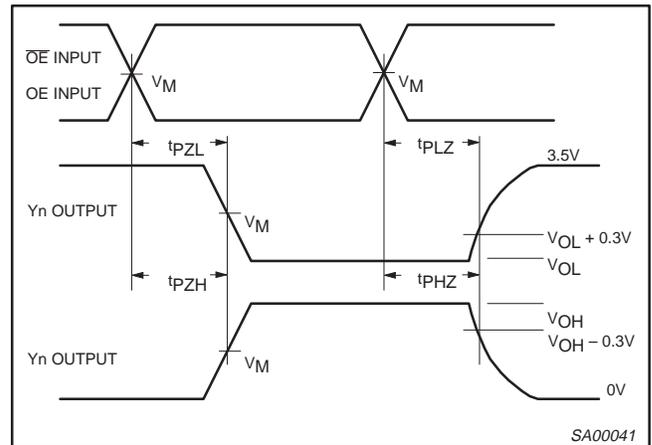
| SYMBOL | PARAMETER | WAVEFORM | LIMITS | | | | | UNIT |
|--------------------------------------|--|----------|--|------------|------------|--|------------|------|
| | | | $T_{\text{amb}} = +25^\circ\text{C}$ $V_{\text{CC}} = +5.0\text{V}$ | | | $T_{\text{amb}} = -40^\circ\text{C to } +85^\circ\text{C}$ $V_{\text{CC}} = +5.0\text{V} \pm 0.5\text{V}$ | | |
| | | | Min | Typ | Max | Min | Max | |
| t_{PLH} t_{PHL} | Propagation delay An to Yn | 1 | 1.0 1.0 | 2.6 2.7 | 4.1 4.2 | 1.0 1.0 | 4.6 4.6 | ns |
| t_{PZH} t_{PZL} | Output enable time to High and Low level | 2 | 1.1 1.3 | 3.2 4.3 | 6.3 5.8 | 1.1 1.3 | 6.8 6.8 | ns |
| t_{PHZ} t_{PLZ} | Output disable time from High and Low level | 2 | 1.6 1.0 | 3.6 2.6 | 6.1 5.4 | 1.6 1.0 | 7.1 5.9 | ns |

AC WAVEFORMS

$V_M = 1.5\text{V}$, $V_{\text{IN}} = \text{GND to } 3.0\text{V}$



Waveform 1. Waveforms Showing the Input (An) to Output (Yn) Propagation Delays



Waveform 2. Waveforms Showing the 3-State Output Enable and Disable Times

TEST CIRCUIT AND WAVEFORMS

From Output Under Test

$C_L = 50\text{ pF}$

500 Ω

500 Ω

7 V

Open

GND

S1

Load Circuit

| TEST | S1 |
|---------------------------------|------|
| t_{pd} | open |
| $t_{\text{PLZ}}/t_{\text{PZL}}$ | 7 V |
| $t_{\text{PHZ}}/t_{\text{PZH}}$ | open |

DEFINITIONS
 $C_L =$ Load capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.

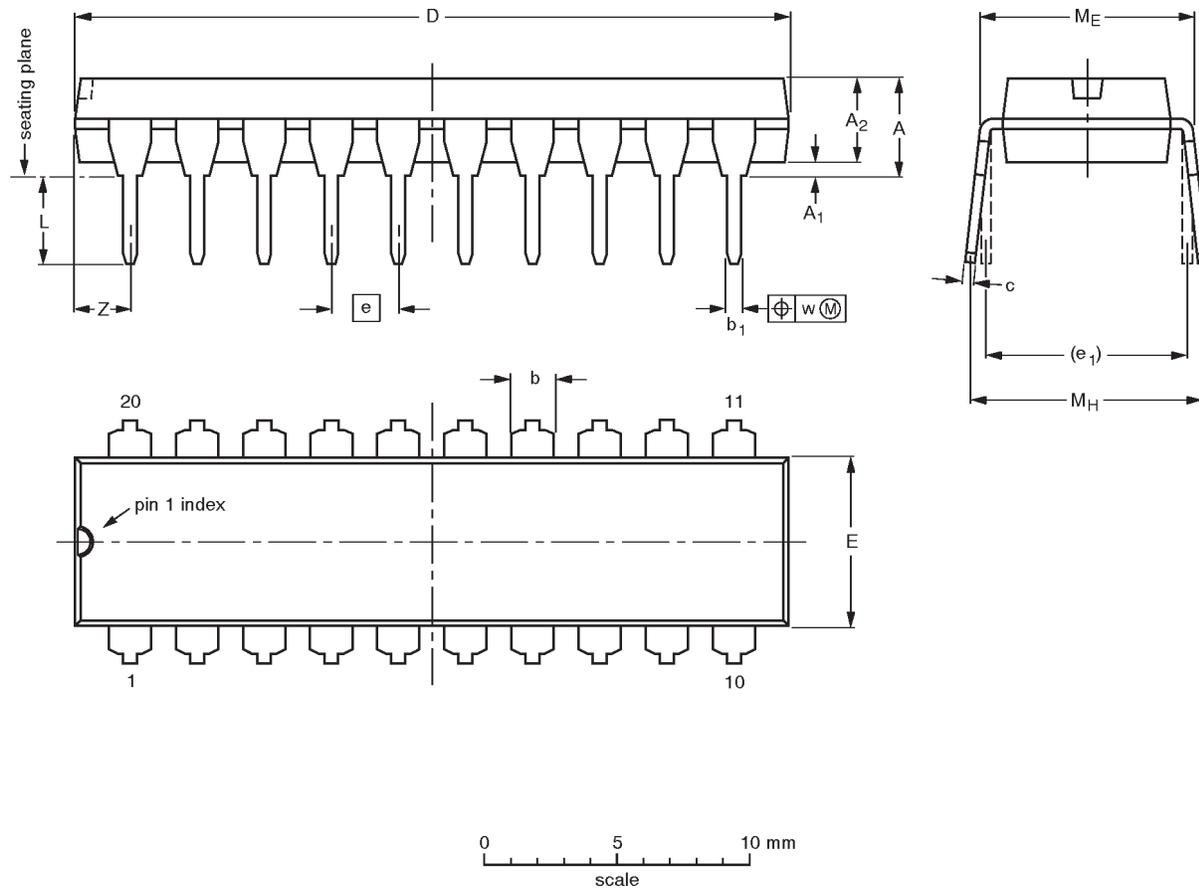
SA00012

Octal buffer/line driver (3-State)

74ABT241

DIP20: plastic dual in-line package; 20 leads (300 mil)

SOT146-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | A max. | A ₁ min. | A ₂ max. | b | b ₁ | c | D ⁽¹⁾ | E ⁽¹⁾ | e | e ₁ | L | M _E | M _H | w | Z ⁽¹⁾ max. |
|--------|--------|---------------------|---------------------|----------------|----------------|----------------|------------------|------------------|------|----------------|--------------|----------------|----------------|-------|-----------------------|
| mm | 4.2 | 0.51 | 3.2 | 1.73 1.30 | 0.53 0.38 | 0.36 0.23 | 26.92 26.54 | 6.40 6.22 | 2.54 | 7.62 | 3.60 3.05 | 8.25 7.80 | 10.0 8.3 | 0.254 | 2.0 |
| inches | 0.17 | 0.020 | 0.13 | 0.068 0.051 | 0.021 0.015 | 0.014 0.009 | 1.060 1.045 | 0.25 0.24 | 0.10 | 0.30 | 0.14 0.12 | 0.32 0.31 | 0.39 0.33 | 0.01 | 0.078 |

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

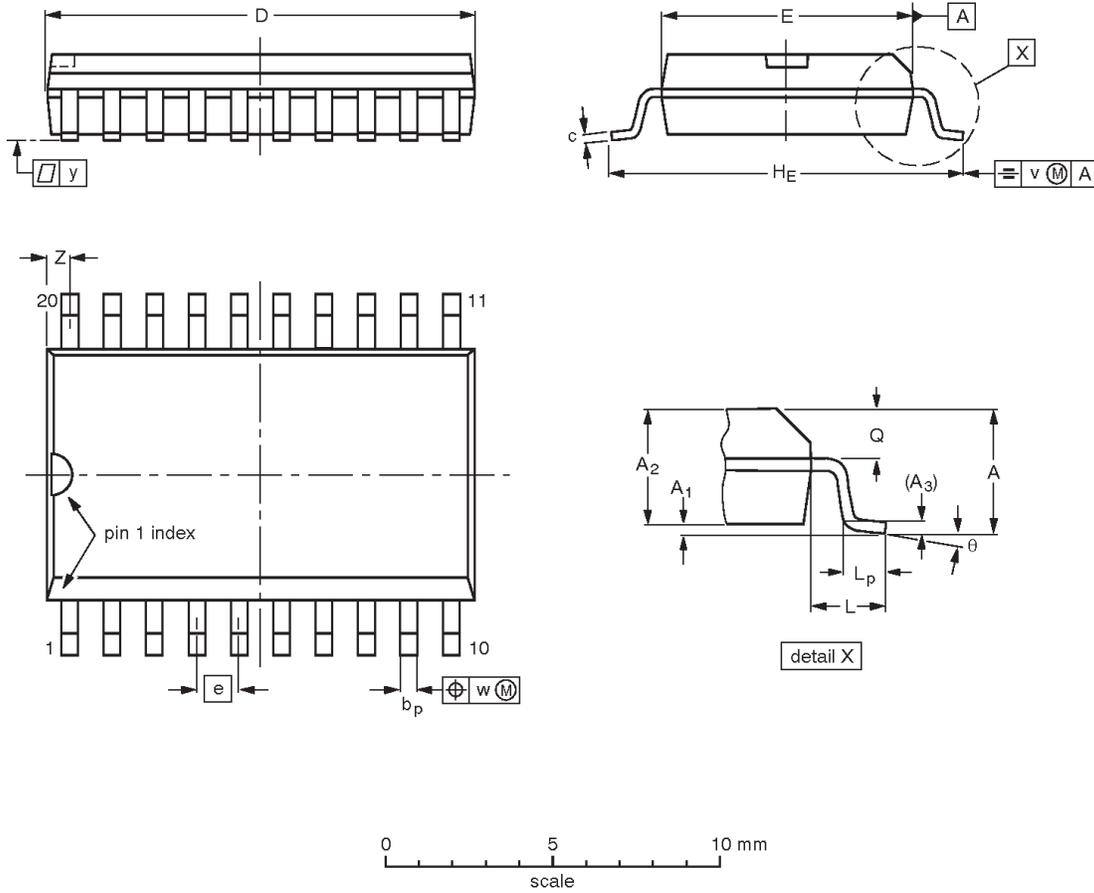
| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|-------|-------|--|---|----------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT146-1 | | | SC603 | |  | 92-11-17 95-05-24 |

Octal buffer/line driver (3-State)

74ABT241

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽¹⁾ | e | HE | L | L _p | Q | v | w | y | Z ⁽¹⁾ | θ |
|--------|--------------|----------------|----------------|----------------|----------------|----------------|------------------|------------------|-------|----------------|-------|----------------|----------------|------|------|-------|------------------|----------|
| mm | 2.65 0.10 | 0.30 0.10 | 2.45 2.25 | 0.25 | 0.49 0.36 | 0.32 0.23 | 13.0 12.6 | 7.6 7.4 | 1.27 | 10.65 10.00 | 1.4 | 1.1 0.4 | 1.1 1.0 | 0.25 | 0.25 | 0.1 | 0.9 0.4 | 8° 0° |
| inches | 0.10 | 0.012 0.004 | 0.096 0.089 | 0.01 | 0.019 0.014 | 0.013 0.009 | 0.51 0.49 | 0.30 0.29 | 0.050 | 0.42 0.39 | 0.055 | 0.043 0.016 | 0.043 0.039 | 0.01 | 0.01 | 0.004 | 0.035 0.016 | |

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

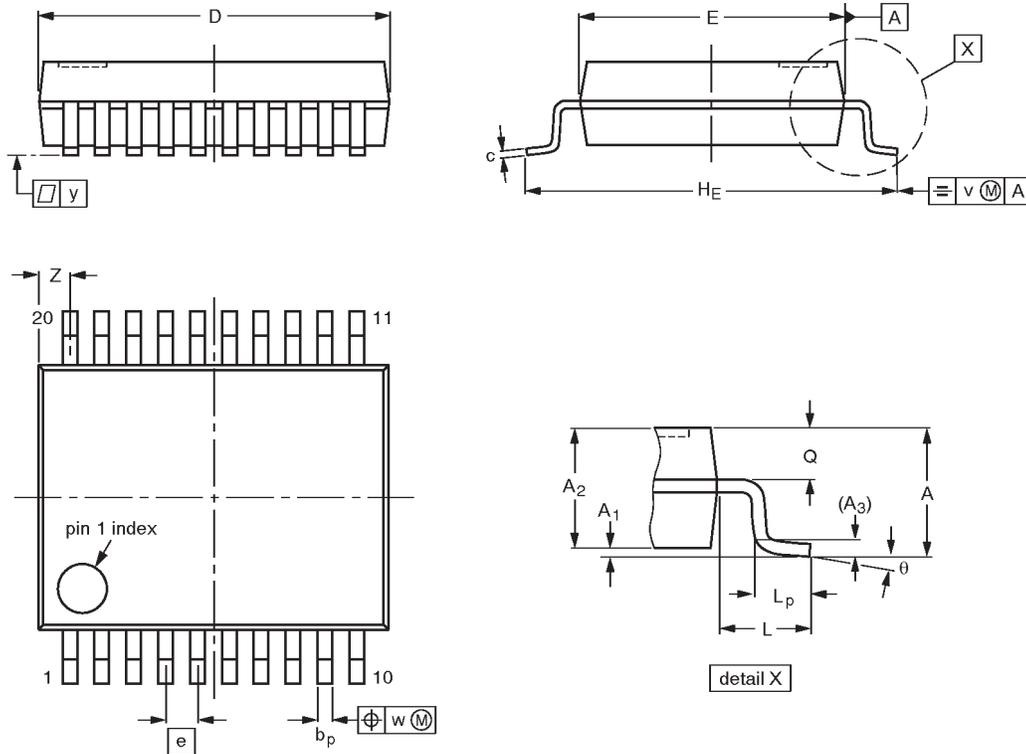
| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|----------|------|--|---------------------|-----------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT163-1 | 075E04 | MS-013AC | | | | -92-11-17 95-01-24 |

Octal buffer/line driver (3-State)

74ABT241

SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽¹⁾ | e | H _E | L | L _p | Q | v | w | y | Z ⁽¹⁾ | θ |
|------|--------|----------------|----------------|----------------|----------------|--------------|------------------|------------------|------|----------------|------|----------------|------------|-----|------|-----|------------------|----------|
| mm | 2.0 | 0.21 0.05 | 1.80 1.65 | 0.25 | 0.38 0.25 | 0.20 0.09 | 7.4 7.0 | 5.4 5.2 | 0.65 | 7.9 7.6 | 1.25 | 1.03 0.63 | 0.9 0.7 | 0.2 | 0.13 | 0.1 | 0.9 0.5 | 8° 0° |

Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

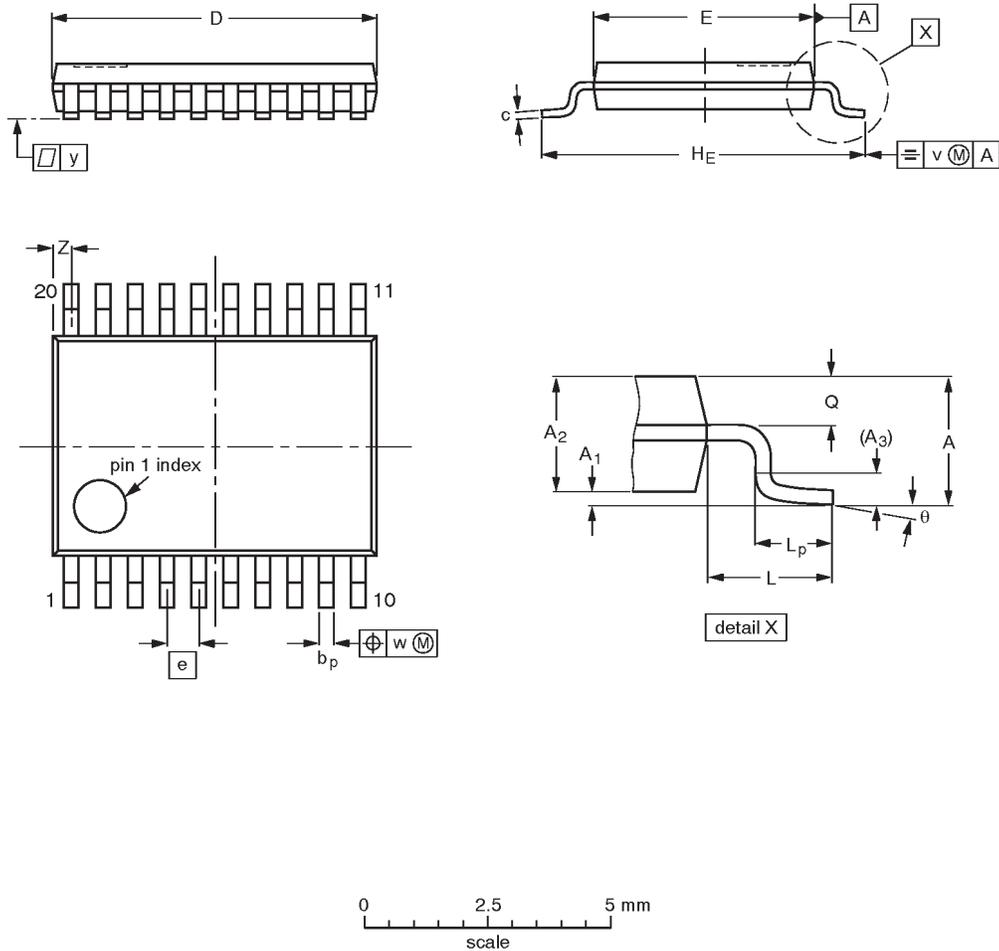
| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|----------|------|--|---------------------|----------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT339-1 | | MO-150AE | | | | 93-09-08 95-02-04 |

Octal buffer/line driver (3-State)

74ABT241

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽²⁾ | e | H _E | L | L _p | Q | v | w | y | z ⁽¹⁾ | θ |
|------|--------|----------------|----------------|----------------|----------------|------------|------------------|------------------|------|----------------|-----|----------------|------------|-----|------|-----|------------------|----------|
| mm | 1.10 | 0.15 0.05 | 0.95 0.80 | 0.25 | 0.30 0.19 | 0.2 0.1 | 6.6 6.4 | 4.5 4.3 | 0.65 | 6.6 6.2 | 1.0 | 0.75 0.50 | 0.4 0.3 | 0.2 | 0.13 | 0.1 | 0.5 0.2 | 8° 0° |

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|----------|------|--|---------------------|-----------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT360-1 | | MO-153AC | | | | -93-06-16 95-02-04 |

Octal buffer/line driver (3-State)

74ABT241

Data sheet status

| Data sheet status | Product status | Definition [1] |
|---------------------------|----------------|--|
| Objective specification | Development | This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice. |
| Preliminary specification | Qualification | This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product. |
| Product specification | Production | This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product. |

[1] Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Disclaimers

Life support — These products are not designed for use in life support appliances, devices or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

Right to make changes — Philips Semiconductors reserves the right to make changes, without notice, in the products, including circuits, standard cells, and/or software, described or contained herein in order to improve design and/or performance. Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no license or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

Philips Semiconductors
811 East Arques Avenue
P.O. Box 3409
Sunnyvale, California 94088-3409
Telephone 800-234-7381

© Copyright Philips Electronics North America Corporation 1998
All rights reserved. Printed in U.S.A.

print code

Date of release: 05-96

Document order number:

3997-750-03464

Let's make things better.